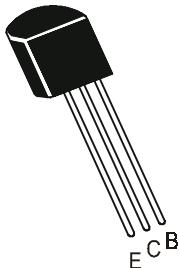


NPN SILICON PLANAR EPITAXIAL TRANSISTORS
CSC460

**TO-92
Plastic Package**
High Frequency And VHF Amplifier Mixer
ABSOLUTE MAXIMUM RATINGS (Ta=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	VALUE	UNIT
Collector Emitter Voltage	V_{CEO}	30	V
Collector Base Voltage	V_{CBO}	30	V
Emitter Base Voltage	V_{EBO}	5	V
Collector Current Continuous	I_C	100	mA
Power Dissipation @ Ta=25°C	P_C	200	mW
Operating And Storage Junction	T_j, T_{stg}	-55 to +125	°C
Temperature Range			

ELECTRICAL CHARACTERISTICS (Ta=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	VALUE			UNIT
			MIN	TYP	MAX	
Collector Emitter Voltage	V_{CEO}	$I_C=1\text{mA}, R_{BE}=0$	30			V
Collector Base Voltage	V_{CBO}	$I_C=10\mu\text{A}, I_E=0$	30			V
Emitter Base Voltage	V_{EBO}	$I_E=10\mu\text{A}, I_C=0$	5			V
Collector Cut off Current	I_{CBO}	$V_{CB}=18\text{V}, I_E = 0$		0.5		μA
Emitter Cut off Current	I_{EBO}	$V_{EB}=2\text{V}, I_C = 0$		0.5		μA
Base Emitter (on) Voltage	$V_{BE\text{ (on)}}$	$I_C=2\text{mA}, V_{CE}=12\text{V}$		0.75		V
Collector Emitter Saturation Voltage	$V_{CE\text{(sat)}}$	$I_C=10\text{mA}, I_B=1\text{mA}$		1.1		V
DC Current Gain	h_{FE}	$I_C=2\text{mA}, V_{CE}=12\text{V}$	35		200	

SMALL SIGNAL CHARACTERISTICS

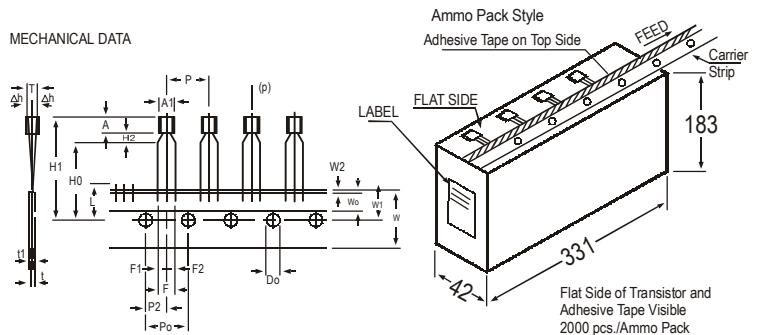
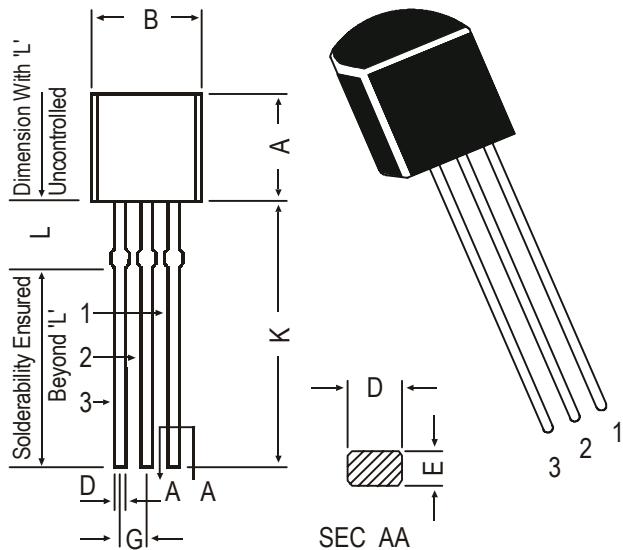
Current Gain Bandwidth Product	f_T	$I_C=2\text{mA}, V_{CE}=12\text{V}$	230	MHz
Output Capacitance	C_{ob}	$I_E=0, V_{CB}=10\text{V}$ $f=1\text{MHz}$	3.5	pF
Noise Figure	NF	$V_{CE} = 6\text{V}, I_C=2\text{mA}$ $R_g=500\Omega, f=1\text{MHz}$	5	dB

h_{FE} CLASSIFICATION	A : 35-70	B: 60-150	C: 100-200
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TO-92 Plastic Package

TO-92 Plastic Package

TO-92 Transistors on Tape and Ammo Pack



All dimensions in mm unless specified otherwise

ITEM	SYMBOL	SPECIFICATION				REMARKS
		MIN.	NOM.	MAX.	TOL.	
BODY WIDTH	A1	4.0		4.8		
BODY HEIGHT	A	4.8		5.2		
BODY THICKNESS	T	3.9		4.2		
PITCH OF COMPONENT	P	12.7			± 1	
FEED HOLE PITCH	Po	12.7			± 0.3	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH
FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		± 0.4	TO BE MEASURED AT BOTTOM OF CLINCH
DISTANCE BETWEEN OUTER LEADS	F	5.08			± 0.6	
COMPONENT ALIGNMENT	Δh	0		1	-0.2	AT TOP OF BODY
TAPE WIDTH	W	18			± 0.5	
HOLD-DOWN TAPE WIDTH	Wo	6			± 0.2	
HOLE POSITION	W1	9			± 0.7	
HOLD-DOWN TAPE POSITION	W2	0.5			± 0.2	
LEAD WIRE CLINCH HEIGHT	Ho	16			± 0.5	
COMPONENT HEIGHT	H1		23.25			
LENGTH OF SNIPPED LEADS	L		11.0			
FEED HOLE DIAMETER	Do	4		1.2	± 0.2	
TOTAL TAPE THICKNESS	t		2.54		± 0.4	t1 0.3 - 0.6
LEAD - TO - LEAD DISTANCE F1, F2					-0.1	
CLINCH HEIGHT	H2		3			
PULL - OUT FORCE	(P)	6N				

NOTES

1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm.
2. MAXIMUM NON-CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1 mm IN 20 PITCHES.
3. HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.
4. NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED.
5. A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT.
6. SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

All dimensions in mm.

PIN CONFIGURATION

1. BASE
2. COLLECTOR
3. Emitter

DIM	MIN.	MAX.
A	4.32	5.33
B	4.45	5.20
C	3.18	4.19
D	0.41	0.55
E	0.35	0.50
F	5 DEG	
G	1.14	1.40
H	1.14	1.53
K	12.70	—
L	1.982	2.082

Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

Disclaimer

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